



Zytel® HTNLTFR52G30NH BL662

HIGH PERFORMANCE POLYAMIDE RESIN

Zytel® HTN high performance polyamide resins feature high retention of properties upon exposure to elevated temperature, to high moisture, and to harsh chemical environments. Polymer families and grades of Zytel® HTN are tailored to optimize performance as well as processability.

Typical applications with Zytel® HTN include demanding applications in the automotive, electrical and electronics, domestic appliances, and construction industries.

Zytel® HTNLTFR52G30NH BL662 is a 30% glass reinforced, flame retardant high performance polyamide resin developed for laser welding applications. It is also a PPA resin and it uses a non-halogenated flame retardant.

Product information

Resin Identification Part Marking Code Part Marking Code ISO designation	>PA6T/66-GF30FR(40)<		ISO 1043 ISO 11469 SAE J1344 1CF1G,S10-110
Rheological properties	dry/cond.		
Moulding shrinkage, parallel Moulding shrinkage, normal	0.3/- 0.8/-	% %	ISO 294-4, 2577 ISO 294-4, 2577
Typical mechanical properties	dry/cond.		
Tensile modulus Tensile stress at break, 5mm/min Tensile strain at break, 5mm/min Flexural modulus Flexural strength Charpy impact strength, 23°C Charpy impact strength, -30°C Charpy notched impact strength, -30°C Poisson's ratio	10800/10400 148/125 2.2/2.2 10500/10000 220/190 46/40 40/40 6/6 6/5 0.34/0.34	MPa MPa % MPa MPa kJ/m² kJ/m² kJ/m²	ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 178 ISO 178 ISO 179/1eU ISO 179/1eU ISO 179/1eA ISO 179/1eA
Thermal properties	dry/cond.		
Melting temperature, 10 °C/min Melting temperature, first heat Glass transition temperature, 10 °C/min Temperature of deflection under load, 1.8 MPa Coeff. of linear therm. expansion, parallel, -40-23 °C Coefficient of linear thermal expansion	310/* 310/* 90/45 283/* 21/* 25/*	°C °C °C °C E-6/K E-6/K	ISO 11357-1/-3 ISO 11357-1/-3 ISO 11357-1/-3 ISO 75-1/-2 ISO 11359-1/-2
(CLTE), parallel Coeff. of linear therm. expansion, parallel, 55-160°C Coeff. of linear therm. expansion, normal, -40-23°C Coefficient of linear thermal expansion (CLTE),	27/* 57/* 68/*	E-6/K E-6/K E-6/K	ISO 11359-1/-2 ISO 11359-1/-2 ISO 11359-1/-2
normal Coeff. of linear therm. expansion, normal, 55-160°C RTI, electrical, 0.4mm RTI, electrical, 1.5mm RTI, electrical, 3.0mm	118/* 140 140 140	E-6/K °C °C °C	ISO 11359-1/-2 UL 746B UL 746B UL 746B

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RTI, impact, 1.5mm	115	°C	UL 746B
RTI, impact, 3.0mm	120	°C	UL 746B
RTI, strength, 1.5mm	125/*	°C	UL 746B
RTI, strength, 3.0mm	130	°C	UL 746B

dry/cond.

dry/cond.

dry/cond.

Flammability

Burning Behav. at 1.5mm nom. thickn.	V-0/*	class	IEC 60695-11-10
UL recognition	yes/*		UL 94
Burning Behav. at thickness h	V-0/*	class	IEC 60695-11-10
Thickness tested	0.4/*	mm	IEC 60695-11-10
UL recognition	yes/*		UL 94

Electrical properties

Comparative tracking index	600/-		IEC 60112
Electric Strength, Short Time, 2mm	27/-	kV/mm	IEC 60243-1

Physical/Other properties

Humidity absorption, 2mm	1.6/*	%	Sim. to ISO 62
Water absorption, 2mm	3.9/*	%	Sim. to ISO 62
Density	1450/-	kg/m³	ISO 1183

Injection

Drying Recommended	yes
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	6-8 h
Processing Moisture Content	≤0.1 %
Min. melt temperature	320 °C
Max. melt temperature	325 °C
Min. mould temperature	90 °C
Max. mould temperature	130 °C

Characteristics

Processing Injection Moulding

Flame retardant, Non-halogenated/Red phosphorous free flame retardant Additives

Special characteristics Flame retardant

Additional information

Injection molding For molding machine components, use corrosion resistant and wear resistant

steel. For details please contact our representative. Limit the residence time of the resin in the machine. Use proper protective equipment and adequate

ventilation.

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